

MAX33012E Shield

Evaluates: MAX33012E

General Description

The MAX33012E Shield is a fully assembled and tested Printed Circuit Board (PCB) that demonstrates the functionality of the MAX33012E, a high $\pm 65V$ fault-protection, $\pm 25V$ common mode input range, $\pm 25kV$ ESD Human Body Model (HBM) controller area network (CAN) transceiver. The Mbed/Arduino shield can also be used as a standalone evaluation board. The shield features a digital isolator, which is used as a level translator between the CAN transceiver and the controller interface.

Features

- Easy Evaluation of the MAX33012E
- I/O Interface Compatibility From 1.71V to 5.5V
- Proven PCB Layout
- Mbed/Arduino Platform Compatible
- Fully Assembled and Tested

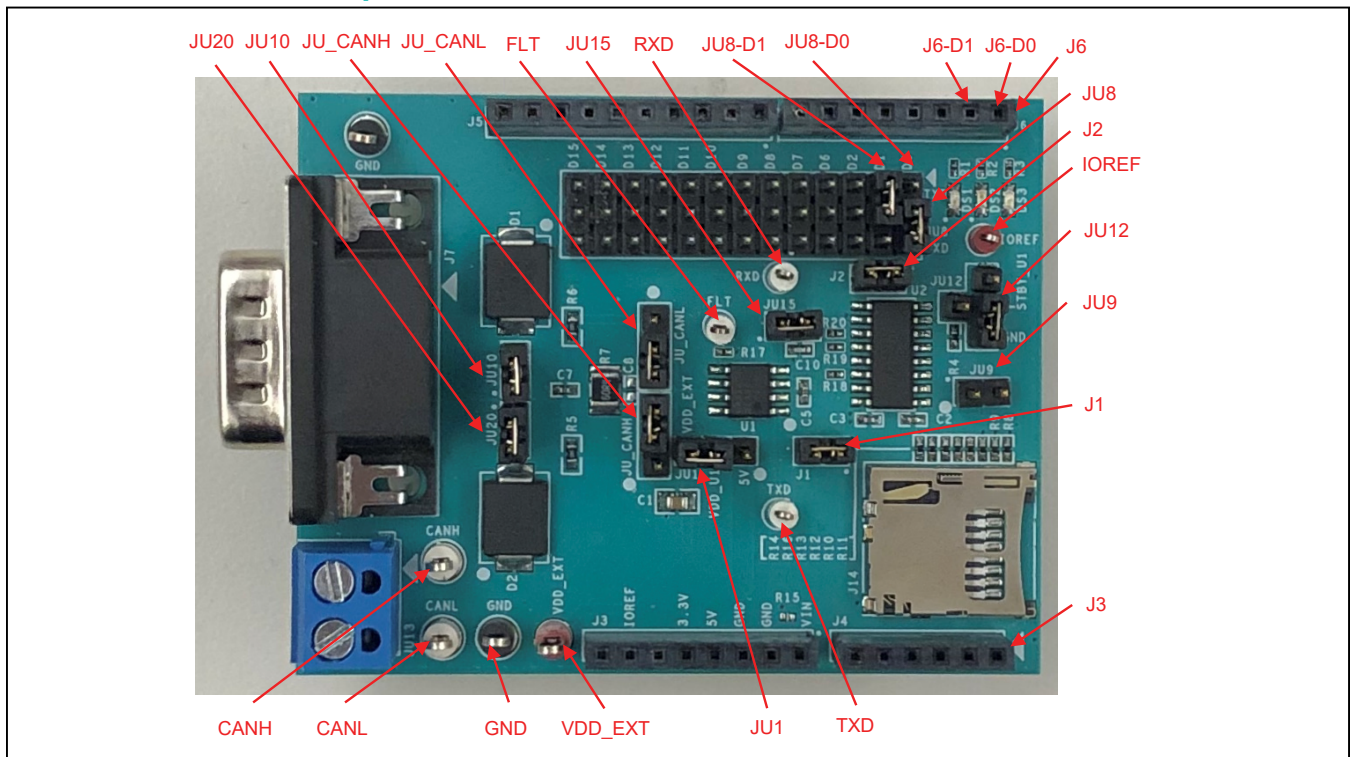
Quick Start

Required Equipments

- MAX33012E Shield
- 5V, 500mA DC power supply
- Signal/function generator that can generate 2.5MHz square wave signal
- Oscilloscope

Ordering Information appears at end of data sheet.

EV Kit Photo with Jumpers and Test Points Position



Procedure

- 1) Place the MAX33012E Shield on a nonconductive surface to ensure that nothing on the PCB gets shorted to the workspace.
- 2) Set all jumpers in their default position as shown in [Table 1](#).
- 3) With +5V power supply disabled, connect the positive terminal to VDD_EXT and IOREF test points. Connect the negative terminal to the GND test point.
- 4) Connect the positive terminal of the function generator to D1 pin of J6 and negative terminal to any GND test points on the shield.
- 5) Set function generator to output a 2.5MHz square wave between 0V and 5V, and then enable function generator output.
- 6) Turn on the +5V DC Power Supply.
- 7) Connect an oscilloscope probe on RXD test point and verify the RXD output signal matches the TXD input signal.

Transmission Failure, Overcurrent and Overvoltage Fault Detection Procedure

In-order to test the fault detection, 100 pulses on TXD are required to enable the fault detection circuitry. There are 3 different faults that can be tested. After each fault condition is applied, fault pin goes high. Send 16 pulses on TXD to observe the fault code on RXD. Additional 10 pulses on TXD are required to clear the Fault and another 100 pulses on TXD to enable fault detection again.

- Remove jumpers JU_CANH and JU_CANL. As the CAN Bus won't have any termination, MAX33012E will detect "Transmission Failure" fault.
- Connect an oscilloscope probe on RXD test point and verify the RXD output signal shows fault code "110010".
- **Overcurrent Fault Detection:** Connect a short wire between pin#2 of JU_CANH and pin#2 of JU_CANL. As the CANH and CANL lines are shorted to each other, MAX33012E will detect "Overcurrent" fault.
- Verify that the RXD output signal shows fault code "101010".
- **Overvoltage Fault Detection:** Remove the wire and follow setup instructions in Figure 1 of the MAX33012E data sheet to observe Overvoltage fault. For Overvoltage fault detection, recommended RCM value is 150Ω and VCM value is 30V.
- Verify that the RXD output signal shows fault code "100110".

Detailed Description of Hardware

The MAX33012E Shield is a fully assembled and tested circuit board for evaluating the MAX33012E fault-protected high-speed CAN transceiver (U1) with $\pm 65V$ of fault protection, fault detection and reporting. The Shield is designed to evaluate MAX33012E alone or in a CAN system. The MAX33012E Shield enables Mbed or Arduino platform to communicate on a CAN bus. The MAX14932 digital isolator is used as a level translator with a 1.71V to 5.5V supply range.

Powering the Board

The MAX33012E Shield requires one power supply for 5V operation. The power supply can come from an external supply or from the Arduino/Mbed microcontroller's 5V supply. Shunt the JU1 VDD pin to VDD_EXT pin option (2-3 default position) to select the external supply. Shunt JU1 VDD pin to 5V (1-2 position) to connect the Arduino/Mbed 5V supply to VDD.

On-Board Termination

A properly terminated CAN bus is terminated at each end with the characteristic impedance of the cable. For CAT5 or CAT6 cables, this is typically 120Ω on each end for a 60Ω load on the CAN driver. The MAX33012E shield features a selectable 60Ω load and a 60Ω-60Ω split termination circuit between the CANH and CANL driver outputs. The 60Ω-60Ω split termination has a footprint for a capacitor to reduce high-frequency noise and common mode drift. If the board is evaluated in a system and is connected at the end of the cable, then select the 120Ω (60Ω-60Ω split) termination. To simulate a complete system without connecting to another CAN transceiver, change the termination resistors on the MAX33012E Shield to a 60Ω with optional footprint for a 100pF load.

TXD and RXD Configuration

Digital channels for TXD and RXD are selected via JU8. It consists of three columns, and 14 rows. The columns labeled TXD and RXD are connected to MAX33012E through the digital isolator U2. The middle column is the digital I/O pins, D0 to D13. This provides flexibility for the user to select different resources on the microcontroller to transmit and receive signals to and from the CAN transceiver. [Table 2](#) shows the list of JU8 jumper options.

DB9 Connector

The MAX33012E Shield has a DB9 connector to CANH and CANL (pins 7 and 6, respectively).

SD Card

The MAX33012E Shield has a SD Card socket. The Micro SD card is connected to D10–D13 to interface with Arduino/Mbed board through SPI interface.

Table 1. Table Jumper Settings

| JUMPER | SHUNT POSITION | DESCRIPTION |
|---------------------|----------------|---------------------------------------------------------------------|
| JU_CANH and JU_CANL | 1-2 | Connects 120.8Ω between CANH and CANL |
| | 2-3* | Connects 60.4Ω between CANH and CANL |
| | Open | No load is connected between CANH and CANL |
| JU1 | 1-2 | Connects V _{DD} to 5V supply |
| | 2-3* | Connects V _{DD} to VDD_EXT supply |
| | Open | Disconnects V _{DD} |
| JU8 | — | Refer to TXD and RXD Configuration in Table 2 |
| JU9 JU10 | 1-2 | Connects STBY to D7 of J6 |
| | Open* | Disconnects STBY from D7 of J6 |
| JU10 JU12 | 1-2* | Connects TVS diode to CANL |
| | Open | Disconnects TVS diode from CANL |
| JU12 | 1-2* | Connects STBY to ground |
| | 1-3 | Connects 26.1KΩ resistor between STBY and ground |
| | 1-4 | Connects STBY to the U2's OUTB2 pin used for Arduino/Mbed interface |
| | Open | Internal pull up for standby mode |
| JU15 | 1-2* | Connects 15pF capacitor between receiver output and ground |
| | Open | Disconnects 15pF capacitor between receiver output and ground |
| JU20 | 1-2* | Connects TVS diode to CANH |
| | Open | Disconnects TVS diode from CANH |
| J1 | 1-2* | Connects V _{DDB} on U2 to V _{DD} |
| | Open | Disconnects V _{DDB} on U2 from V _{DD} |
| J2 | 1-2* | Connects FAULT to D2 pin of J6 |
| | Open | Disconnects FAULT |

Note: ** indicates default jumper state.

Table 2. Table TXD and RXD Jumper Setting

| JUMPER | SHUNT POSITION | DESCRIPTION |
|--------|----------------|---------------------|
| JU8 | 1-2 | Connects TXD to D0 |
| | 4-5* | Connects TXD to D1 |
| | 7-8 | Connects TXD to D2 |
| | 10-11 | Connects TXD to D3 |
| | 13-14 | Connects TXD to D4 |
| | 16-17 | Connects TXD to D5 |
| | 19-20 | Connects TXD to D6 |
| | 22-23 | Connects TXD to D7 |
| | 25-26 | Connects TXD to D8 |
| | 28-29 | Connects TXD to D9 |
| | 31-32 | Connects TXD to D10 |
| | 34-35 | Connects TXD to D11 |
| | 37-38 | Connects TXD to D12 |
| | 40-41 | Connects TXD to D13 |

| JUMPER | SHUNT POSITION | DESCRIPTION |
|--------|----------------|---------------------|
| JU8 | 2-3* | Connects RXD to D0 |
| | 5-6 | Connects RXD to D1 |
| | 8-9 | Connects RXD to D2 |
| | 11-12 | Connects RXD to D3 |
| | 14-15 | Connects RXD to D4 |
| | 17-18 | Connects RXD to D5 |
| | 20-21 | Connects RXD to D6 |
| | 23-24 | Connects RXD to D7 |
| | 26-27 | Connects RXD to D8 |
| | 29-30 | Connects RXD to D9 |
| | 32-33 | Connects RXD to D10 |
| | 35-36 | Connects RXD to D11 |
| | 38-39 | Connects RXD to D12 |
| | 41-42 | Connects RXD to D13 |

Note: ** Indicates default jumper state.

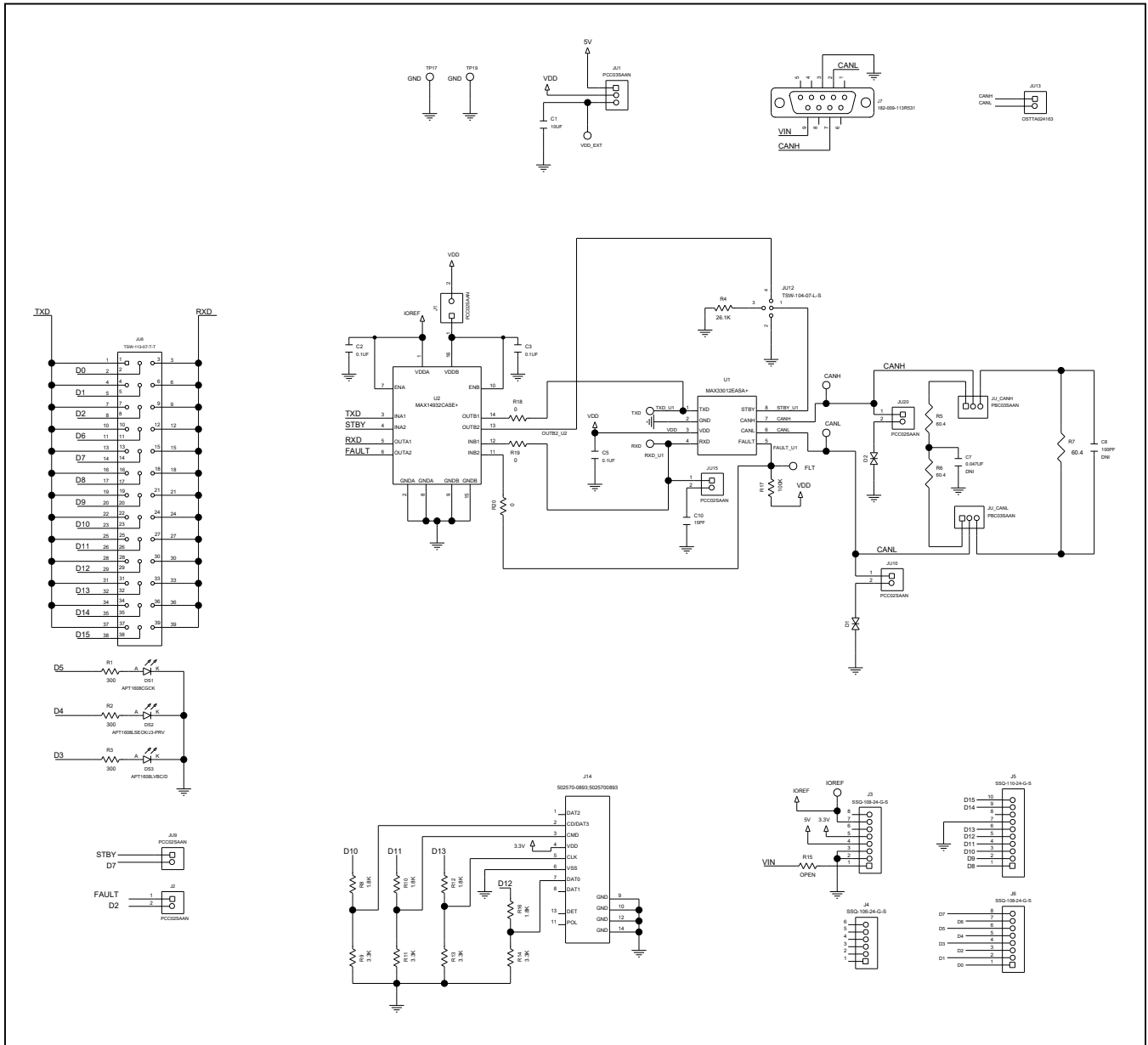
Ordering Information

| PART | TYPE |
|----------------|--------|
| MAX33012ESHLD# | Shield |

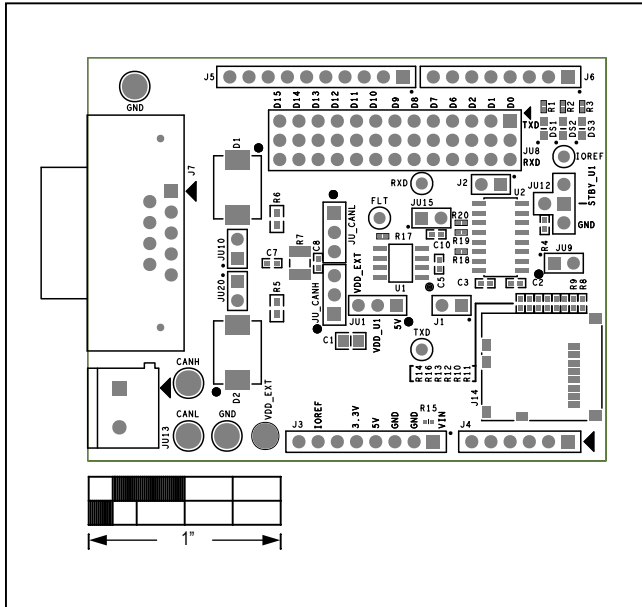
MAX33012E Shield Bill of Materials

| ITEM | REF_DES | DNI/DNP | QTY | MFG PART # | MANUFACTURER | VALUE | DESCRIPTION | COMMENTS |
|-------|----------------------------------|---------|-----|--------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------|------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| 1 | C1 | - | 1 | CL21B106KP0NNN; LMK212AB7106KG; C0805X106K8RACAUTO | SAMSUNG;TAIYO YUDEN;KEMET | 10UF | CAP; SMT (0805); 10UF; 10%; 10V; X7R; CERAMIC CHIP | |
| 2 | C2, C3, C5 | - | 3 | C0402C104J4RAC; GCM155R71C104JA55 | KEMET;MURATA | 0.1UF | CAPACITOR; SMT (0402); CERAMIC CHIP; 0.1UF; 16V; TOL=5%; MODEL=; TG=-55 DEGC TO +125 DEGC; TC=X7R | |
| 3 | C7 | - | 1 | C1005X7R1E473K050B0C; GRM155R71E473K; GCM155R71E473KA55 | TDK;MURATA;MURATA | 0.047UF | CAPACITOR; SMT (0402); CERAMIC CHIP; 0.047UF; 25V; TOL=10%; TG=-55 DEGC TO +125 DEGC | |
| 4 | C10 | - | 1 | C0402C0G500-150JNP; GRM1555C1H150JA01; GCM1555C1H150JA16 | VENKEL LTD.;MURATA;MURATA | 15PF | CAPACITOR; SMT (0402); CERAMIC CHIP; 15PF; 50V; TOL=5%; TG=-55 DEGC TO +125 DEGC; TC=C0G | |
| 5 | CANH, CANL | - | 2 | 5012 | KEYSTONE | N/A | TEST POINT; PIN DIA=0.125IN; TOTAL LENGTH=0.445IN; BOARD HOLE=0.063IN; WHITE; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH; | |
| 6 | D1, D2 | - | 2 | SM15T30CA | ST MICROELECTRONICS | 25.6V | DIODE; TVS; SMC (DO-214AB); VRM=25.6V; IPP=36A | |
| 7 | DS1 | - | 1 | APT1608CGCK | KINGBRIGHT | APT1608CGCK | DIODE; LED; STANDARD; GREEN; SMT (0603); PIV=2.1V; IF=0.02A; -40 DEGC TO +85 DEGC | |
| 8 | DS2 | - | 1 | APT1608LSECKJ3-PRV | KINGBRIGHT | APT1608LSECKJ3-PRV | DIODE; LED; HYPER RED WATER CLEAR; RED; SMT (0603); VF=1.8V; IF=0.002A | |
| 9 | DS3 | - | 1 | APT1608LVBC/D | KINGBRIGHT | APT1608LVBC/D | DIODE; LED; BLUE WATER CLEAR; BLUE; SMT (0603); VF=2.65V; IF=0.002A | |
| 10 | FLT, RXD, TXD | - | 3 | 5002 | KEYSTONE | N/A | TEST POINT; PIN DIA=0.1IN; TOTAL LENGTH=0.3IN; BOARD HOLE=0.04IN; WHITE; PHOSPHOR BRONZE WIRE SILVER; | |
| 11 | IOREF | - | 1 | 5000 | KEYSTONE | N/A | TEST POINT; PIN DIA=0.1IN; TOTAL LENGTH=0.3IN; BOARD HOLE=0.04IN; RED; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH; | |
| 12 | J1, J2, JU9, JU10, JU15, JU20 | - | 6 | PCC02SAAN | SULLINS | PCC02SAAN | CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT THROUGH; 2PINS; -65 DEGC TO +125 DEGC | |
| 13 | J3, J6 | - | 2 | SSQ-108-24-G-S | SAMTEC | SSQ-108-24-G-S | CONNECTOR; FEMALE; THROUGH HOLE; .025INCH SQ POST SOCKET; STRAIGHT; 8PINS ; | |
| 14 | J4 | - | 1 | SSQ-106-24-G-S | SAMTEC | SSQ-106-24-G-S | CONNECTOR; FEMALE; THROUGH HOLE; .025INCH SQ POST SOCKET; STRAIGHT; 6PINS ; | |
| 15 | J5 | - | 1 | SSQ-110-24-G-S | SAMTEC | SSQ-110-24-G-S | CONNECTOR; FEMALE; THROUGH HOLE; .025INCH SQ POST SOCKET; STRAIGHT; 10PINS ; | |
| 16 | J7 | - | 1 | 182-009-113R531 | NORCOMP | 182-009-113R531 | CONNECTOR; MALE; THROUGH HOLE; D-SUBMINIATURE CONNECTOR; RIGHT ANGLE; 9PINS | |
| 17 | J14 | - | 1 | 502570-0893;5025700893 | MOLEX;MOLEX | 502570-0893;5025700893 | CONNECTOR; FEMALE; SMT; MICROSD CARD CONNECTOR; RIGHT ANGLE; 10PINS | |
| 18 | JU1 | - | 1 | PCC03SAAN | SULLINS | PCC03SAAN | CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT THROUGH; 3PINS; -65 DEGC TO +125 DEGC | |
| 19 | JU8 | - | 1 | TSW-113-07-T-T | SAMTEC | TSW-113-07-T-T | CONNECTOR; MALE; THROUGH HOLE; 0.025IN SQ POST HEADER; STRAIGHT; 39PINS ; | |
| 20 | JU12 | - | 1 | TSW-104-07-L-S | SAMTEC | TSW-104-07-L-S | EVKIT PART-CONNECTOR; MALE; THROUGH HOLE; TSW SERIES; SINGLE ROW; STRAIGHT; 4PINS | |
| 21 | JU13 | - | 1 | OSTTA024163 | ON-SHORE TECHNOLOGY INC. | OSTTA024163 | CONNECTOR; FEMALE; THROUGH HOLE; 5.08MM TERM BLOCK CONNECTOR; STRAIGHT; 2PINS; -30 DEGC TO +105 DEGC | |
| 22 | JU_CANH, JU_CANL | - | 2 | PBC03SAAN | SULLINS | PBC03SAAN | CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT; 3PINS; -65 DEGC TO +125 DEGC | |
| 23 | R1-R3 | - | 3 | CRCW0201300RFFK | VISHAY DALE | 300 | RES; SMT (0201); 300; 1%; +/-100PPM/DEGK; 0.05W | |
| 24 | R4 | - | 1 | CRCW040228K1FFK | VISHAY DALE | 28.1K | RESISTOR; 0402; 28.1K OHM; 1%; 100PPM; 0.063W; THICK FILM | |
| 25 | R5, R6 | - | 2 | CRCW060360R4FFK | VISHAY DALE | 60.4 | RESISTOR; 0603; 60.4 OHM; 1%; 100PPM; 0.10W; THICK FILM | |
| 26 | R7 | - | 1 | CRCW121060R4FKEAHP | VISHAY DRALORIC | 60.4 | RES; SMT (1210); 60.4R; 1%; +/-100PPM/DEGK; 0.75W | |
| 27 | R8, R10, R12, R16 | - | 4 | CRCW04021K80FFK; RC0402FR-071K8L | VISHAY DALE;YAGEO PHICOMP | 1.8K | RESISTOR; 0402; 1.8K OHM; 1%; 100PPM; 0.0625W; THICK FILM | |
| 28 | R9, R11, R13, R14 | - | 4 | CRCW04023K30FFK | VISHAY DALE | 3.3K | RESISTOR; 0402; 3.3K OHM; 1%; 100PPM; 0.0625W; THICK FILM | |
| 29 | R17 | - | 1 | CRCW0201100KFFK | VISHAY DALE | 100K | RESISTOR; 0201; 100K OHM; 1%; 100PPM; 0.05W; THICK FILM | |
| 30 | R18-R20 | - | 3 | RC0201JR-070RL | YAGEO | 0 | RESISTOR; 0201; 0 OHM; 0%; JUMPER; 0.05W; THICK FILM | |
| 31 | TP17, TP19 | - | 2 | 5011 | KEYSTONE | N/A | TEST POINT; PIN DIA=0.125IN; TOTAL LENGTH=0.445IN; BOARD HOLE=0.063IN; BLACK; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH; | |
| 32 | U1 | - | 1 | MAX33012EASA+ | MAXIM | MAX33012EASA+ | EVKIT PART - IC; TXRX; +5V; SMBPS CAN TRANSCEIVER WITH +/-65V FAULT PROTECTION FAULT DETECTION AND REPORTING; +/-30V CMR AND +/-25KV ESD PROTECTION; PACKAGE OUTLINE DRAWING: 21-0041; LAND PATTERN NUMBER: 90-0096; PACKAGE CODE: S8+4; NSOIC8 | |
| 33 | U2 | - | 1 | MAX14932CASE+ | MAXIM | MAX14932CASE+ | IC; DISO; 4-CHANNEL; 2.75KVRRMS DIGITAL ISOLATOR; NSOIC16 | |
| 34 | VDD_EXT | - | 1 | 5010 | KEYSTONE | N/A | TEST POINT; PIN DIA=0.125IN; TOTAL LENGTH=0.445IN; BOARD HOLE=0.063IN; RED; PHOSPHOR BRONZE WIRE SIL; | |
| 35 | PCB | - | 1 | MAX33012ESHIELD | MAXIM | PCB | PCB;MAX33012ESHIELD | |
| 36 | C8 | DNP | 0 | C0402C101J5GAC; NMC0402NPO101J; CC0402JRNPO9BN101; GRM1555C1H101JA01; C1005C0G1H101J050BA; CGA2B2C0G1H101J050BA | KEMET;NIC COMPONENTS CORP.; YAGEO PHICOMP;MURATA;TDK;TDK | 100PF | CAPACITOR; SMT (0402); CERAMIC CHIP; 100PF; 50V; TOL=5%; TG=-55 DEGC TO +125 DEGC; TC=C0G | |
| 37 | R15 | DNP | 0 | N/A | N/A | OPEN | RESISTOR; 0402; OPEN; FORMFACTOR | |
| TOTAL | | | 60 | | | | | |

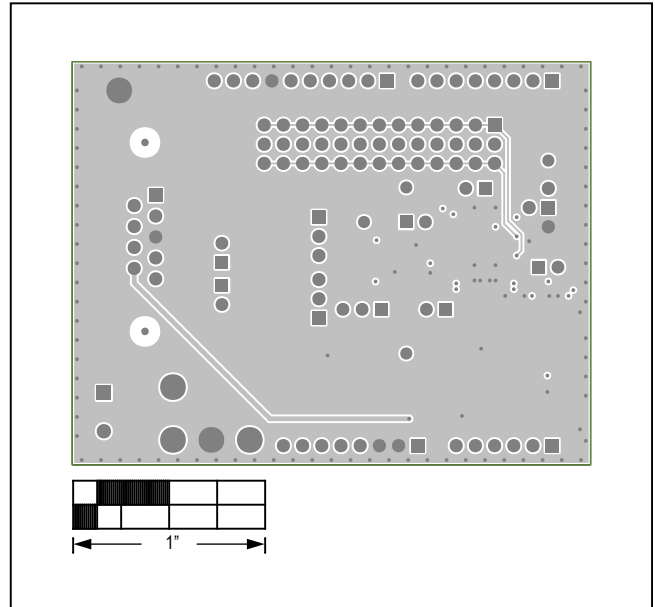
MAX33012E Shield Schematic



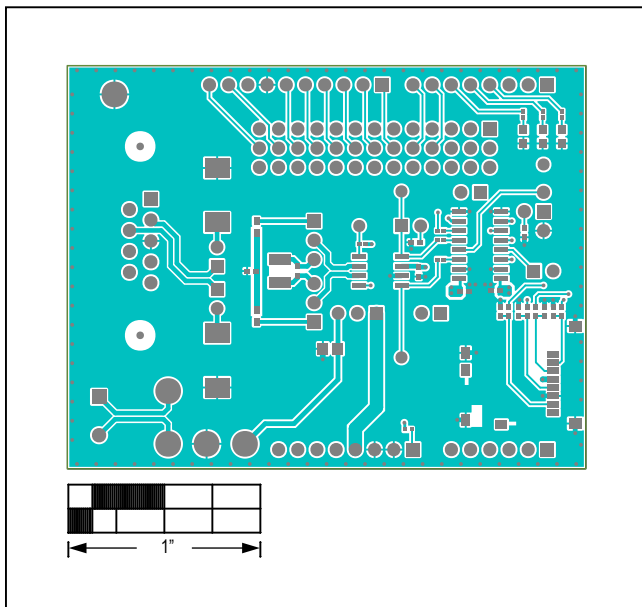
MAX33012E Shield PCB Layout Diagrams



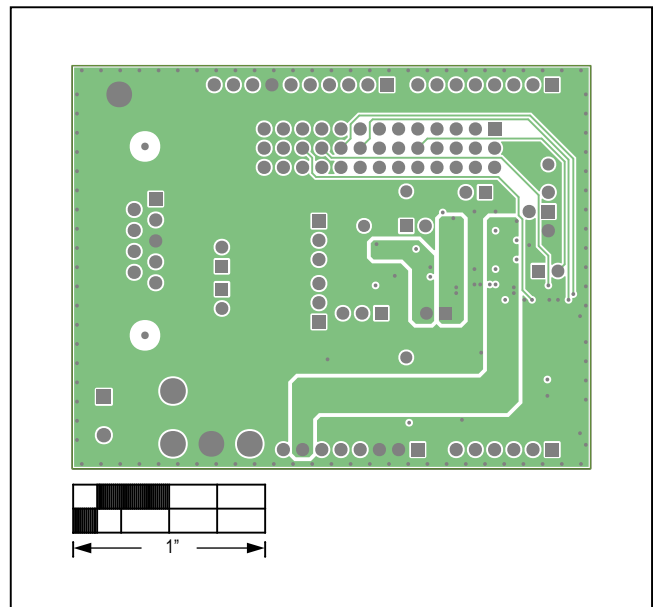
MAX33012E Shield—Top Silkscreen



MAX33012E Shield—Internal 2

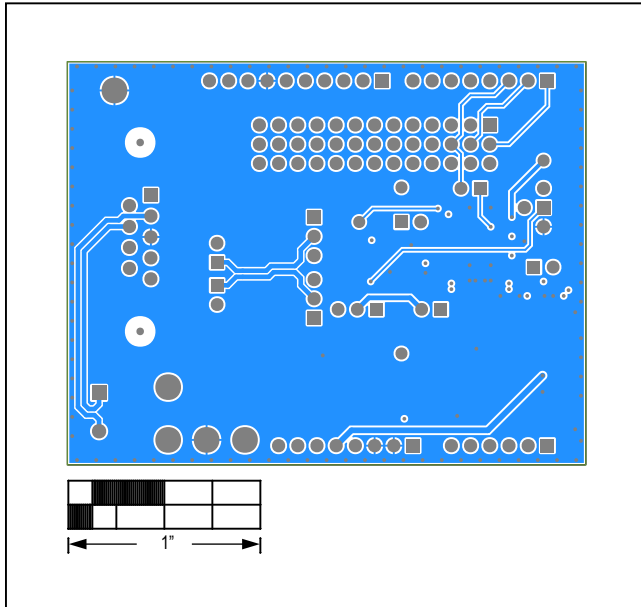


MAX33012E Shield—Top

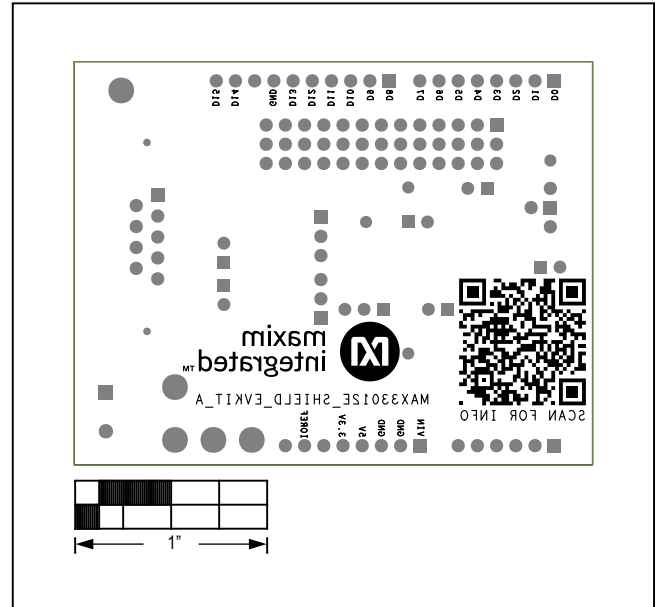


MAX33012E Shield—Internal 3

MAX33012E Shield PCB Layout Diagrams (continued)



MAX33012E Shield—Bottom



MAX33012E Shield—Bottom Silkscreen

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|-----------------|---------------|-----------------|---------------|
| 0 | 11/19 | Initial release | — |

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at <https://www.maximintegrated.com/en/storefront/storefront.html>.

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MAXESSENTIAL01+

Description

The Essential Analog toolkit contains a unique collection of Maxim's high-performance, analog building block products. This curated group of parts represent a selection of Maxim's vast product lines, specific to 20 product categories, from key performance areas including power efficiency, precise measurement, reliable connectivity, and robust protection.

The ICs in the toolkit offer the breadth of each product category: low power, low noise, multi-channel, high resolution, high accuracy, and high speed. All these features empower your designs and bring value to your systems.

At 6.4cm x 8.9cm x 1.3cm, the box itself is small, lightweight, and easy to carry. Products are guarded from ESD using a gel and ESD-protected box.

A guide that labels each of the part types inside the box supports the toolkit. Go to the Maxim website to find more information for the individual part numbers.

When planning your next design, pick up an Essential Analog toolkit to review Maxim's high-performance analog products.

Key Features

- Small, 6.4cm x 8.9cm x 1.3cm Package
- ESD Protection-Lined Package
- Accelerate Your Design with Quick Access



What's Included in the Box?

| Efficient Power | | | | |
|------------------------|------------------------|------------------------|------------------------------|-----------------------|
| Buck | Boost | Buck-Boost | LDO | Continua |
| MAX38640 MAX15026 | MAX17225 MAX668 | MAX77827 MAX77816 | MAX38902B MAX1510 | MAX38888 |
| Precision Measurement | | | | |
| ADC | DAC | Audio Amp | Op Amp | CSA |
| MAX11410 MAX11168 | MAX5541 MAX5715 | MAX98357A MAX98390 | MAX40075 MAX40100 | MAX44284 MAX40201 |
| Reliable Connectivity | | | | |
| RS-485 | RS-232 | CAN | BTR Switch | Wireless |
| MAX14780E MAX3485AE | MAX13235E MAX33250E | MAX13054A MAX33054E | MAX14778 MAX14763 | MAX41460 MAX7034 |
| Robust Protection | | | | |
| Supervisor | Temp Sensor | Isolator | Ideal Diode/V _{REF} | RTC |
| MAX16150 MAX16140 | MAX6680 MAX31875 | MAX12930 MAX22445 | MAX40203 MAX6078A | MAX31341B DS3231MZ |